

N-Channel 60 V (D-S) Super Junction MOSFET

PRODUCT SUMMARY			
V_{DS} (V)	$R_{DS(on)}$ (m Ω) (Typ.)	I_D (A) ^a	Q_g (Typ.)
60	10 at $V_{GS} = 10$ V	50	12.5 nC
	15 at $V_{GS} = 4.5$ V		

FEATURES

- DT-SJ Power MOSFET
- 100 % Rg and UIS tested
- Low on-resistance RDS(on)
- AEC-Q101 Qualified for Automotive Applications

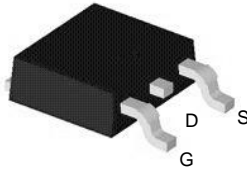


RoHS
COMPLIANT

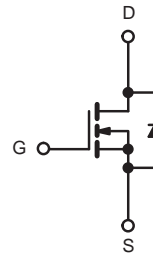
APPLICATIONS

- Power Management
- Motor Drivers

TO-252 Pin Configuration



Top View



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_C = 25$ °C, unless otherwise noted)			
PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current ($T_J = 175$ °C) ^a	I_D	$T_C = 25$ °C	50
		$T_C = 100$ °C	42.2
Pulsed Drain Current ^b	I_{DM}	165	A
Single Avalanche Energy	E_{AS}	125	mJ
Maximum Power Dissipation ^c	P_D	$T_C = 25$ °C	66 ^c
		$T_C = 100$ °C	33
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to +175	°C

THERMAL RESISTANCE RATINGS			
PARAMETER	SYMBOL	LIMIT	UNIT
Junction-to-Ambient (PCB Mount) ^d	R_{thJA}	50	°C/W
Junction-to-Case (Drain)	R_{thJC}	1.9	

Notes

- Calculated continuous current based on maximum allowable junction temperature.
- Repetitive rating; pulse width limited by max. junction temperature.
- P_D is based on max. junction temperature, using junction-case thermal resistance.
- The value of R_{thJA} is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with $T_a = 25$ °C.

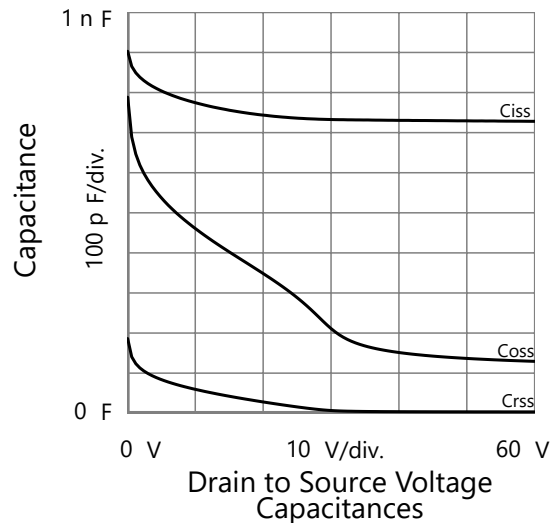
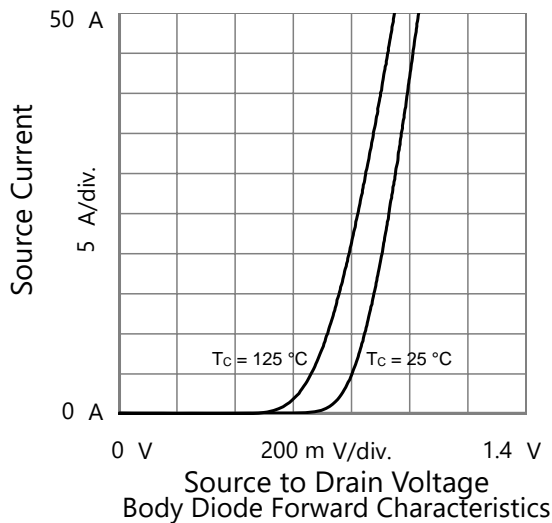
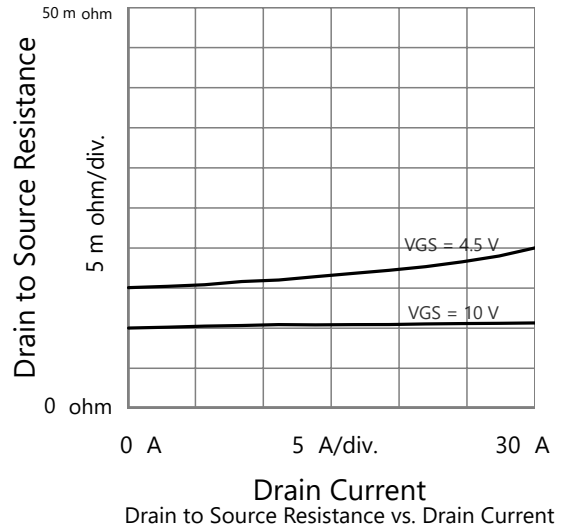
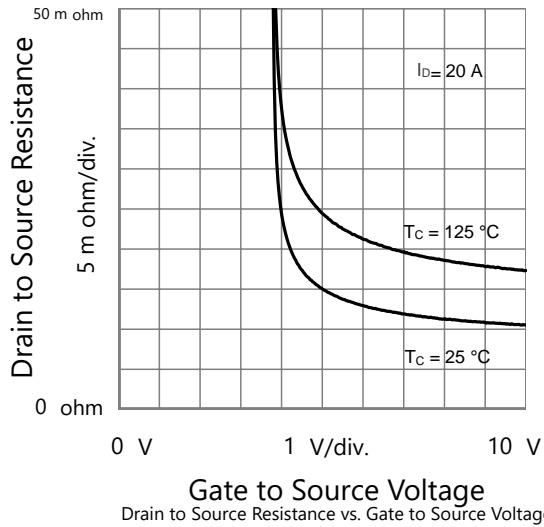
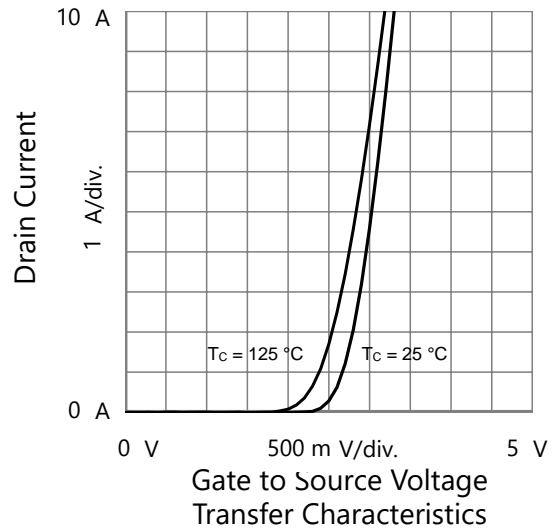
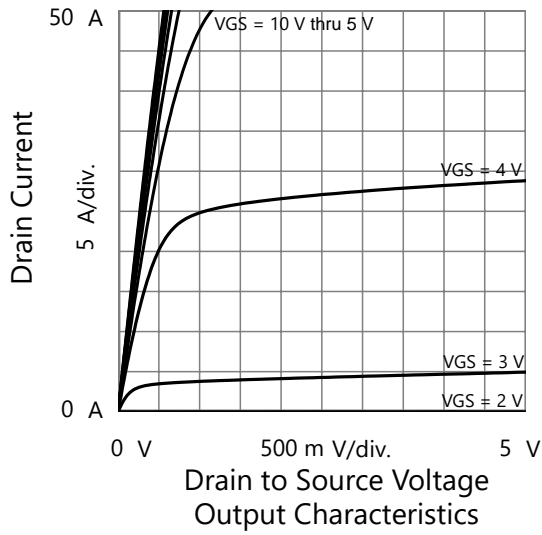
SPECIFICATIONS ($T_C = 25\text{ }^\circ\text{C}$, unless otherwise noted)						
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0, I_D = 250\text{ }\mu\text{A}$	60			V
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	1		3	V
Gate-Source Leakage	I_{GSS}	$V_{DS} = 0\text{ V}, V_{GS} = \pm 10\text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 60\text{ V}, V_{GS} = 0\text{ V}$			1	μA
		$V_{DS} = 48\text{ V}, V_{GS} = 0\text{ V}, T_J = 55\text{ }^\circ\text{C}$			10	
On-State Drain Current ^a	$I_{D(on)}$	$V_{DS} \geq 5\text{ V}, V_{GS} = 10\text{ V}$	50			A
Drain-Source On-State Resistance ^a	$R_{DS(on)}$	$V_{GS} = 10\text{ V}, I_D = 20\text{ A}$		10	13	m Ω
		$V_{GS} = 4.5\text{ V}, I_D = 20\text{ A}$		15	18	
Forward Transconductance ^a	g_{fs}	$V_{DS} = 10\text{ V}, I_D = 20\text{ A}$		50		S
Dynamic^b						
Input Capacitance	C_{iss}	$V_{DS} = 30\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$		730		pF
Output Capacitance	C_{oss}			210		
Reverse Transfer Capacitance	C_{rss}			7		
Total Gate Charge ^c	Q_g	$V_{DS} = 30\text{ V}, V_{GS} = 10\text{ V}, I_D = 20\text{ A}$		12.5		nC
Gate-Source Charge ^c	Q_{gs}			1.6		
Gate-Drain Charge ^c	Q_{gd}			2.3		
Gate Resistance	R_g	$f = 1\text{ MHz}$		2		Ω
Turn-On Delay Time ^c	$t_{d(on)}$	$V_{DD} = 30\text{ V}, I_D = 20\text{ A},$ $R_g = 3\text{ }\Omega, V_{GS} = 10\text{ V}$		8		ns
Rise Time ^c	t_r			5		
Turn-Off Delay Time ^c	$t_{d(off)}$			22		
Fall Time ^c	t_f			6		
Drain-Source Body Diode Characteristics						
Continuous Source-Drain Diode Current	I_S	$T_C = 25\text{ }^\circ\text{C}$			50	A
Pulse Diode Forward Current	I_{SM}				165	
Body Diode Voltage ^a	V_{SD}	$I_S = 1\text{ A}$			1	V
Body Diode Reverse Recovery Time	t_{rr}	$I_F = 20\text{ A}, di/dt = 100\text{ A}/\mu\text{s}, T_J = 25\text{ }^\circ\text{C}$		20		ns
Body Diode Reverse Recovery Charge	Q_{rr}				60	

Notes:

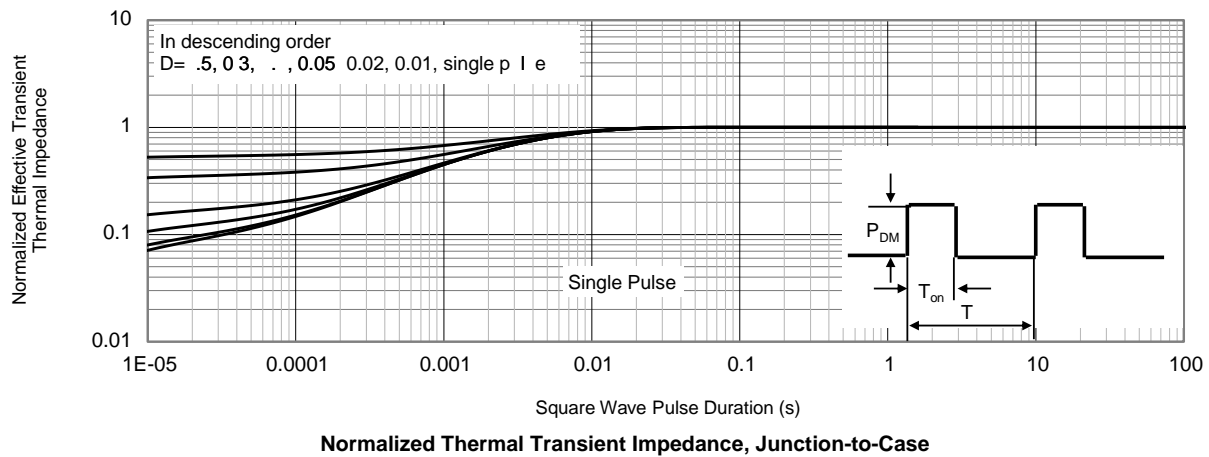
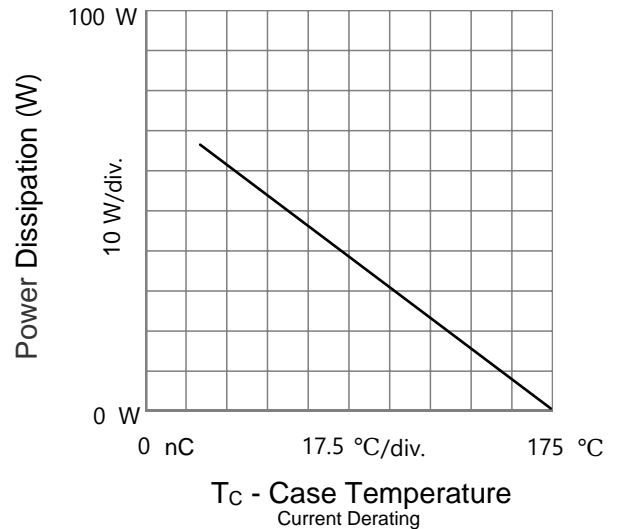
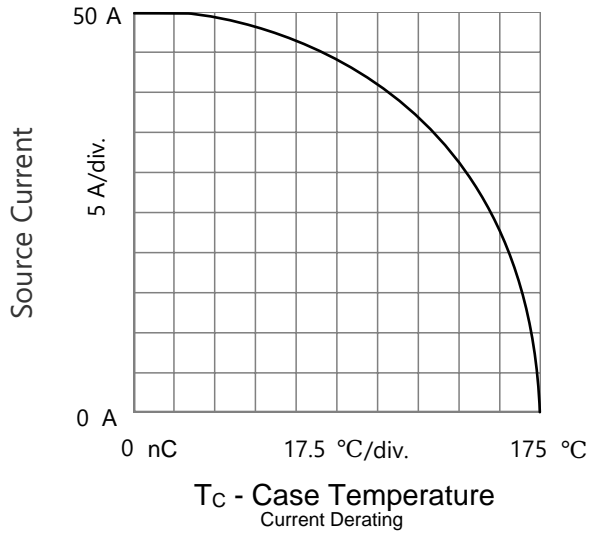
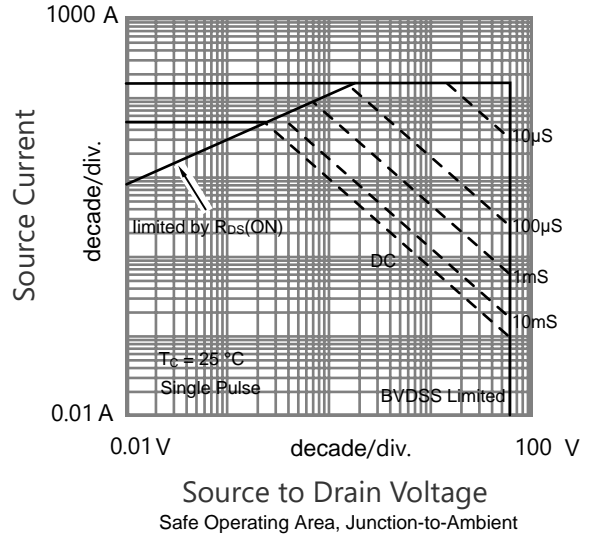
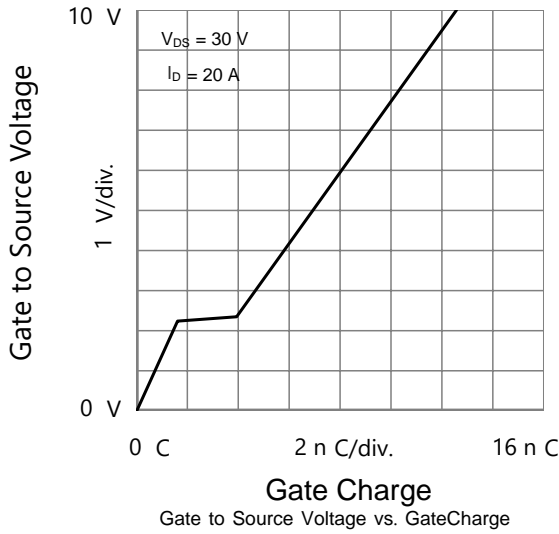
- Pulse test; pulse width 300 μs , duty cycle 2 %.
- Guaranteed by design, not subject to production testing.
- Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

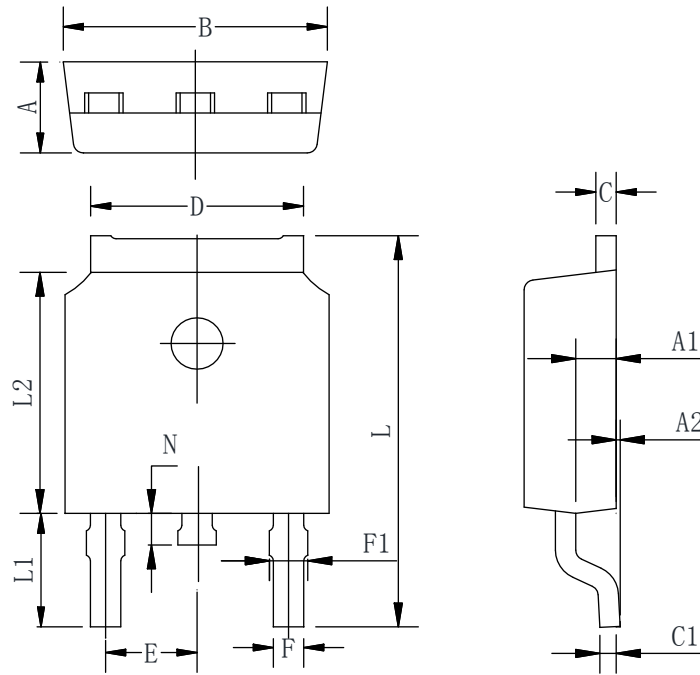
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



TO-252-2L PACKAGE OUTLINE



COMMON DIMENSIONS
(UNITS OF MEASURE=MILLIMETER)

Symbol	Min	Typ	Max
A	2.10	2.30	2.50
A1	0.88	1.01	1.16
A2	0.00	0.15	0.28
B	6.40	6.60	6.80
C	0.42	0.50	0.63
C1	0.42	0.50	0.63
D	5.08	5.32	5.65
E	2.286 TYP		
F	0.63	0.76	0.89
F1	0.64	0.86	1.08
L	9.30	9.90	10.80
L1	2.4	2.8	3.6
L2	5.90	6.10	6.55
N	0.57	0.80	1.05

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